



Shenzhen Yajingxin Electron Co.,Ltd
CRYSTAL UNIT SPECIFICATIONS

Customer	
Production Name	SMD CRYSTAL 5.0*3.2
Customer P/N	N/A
P/N	5032-SMD8.000M20PF
Revision	A
Print Date	2017-9-23

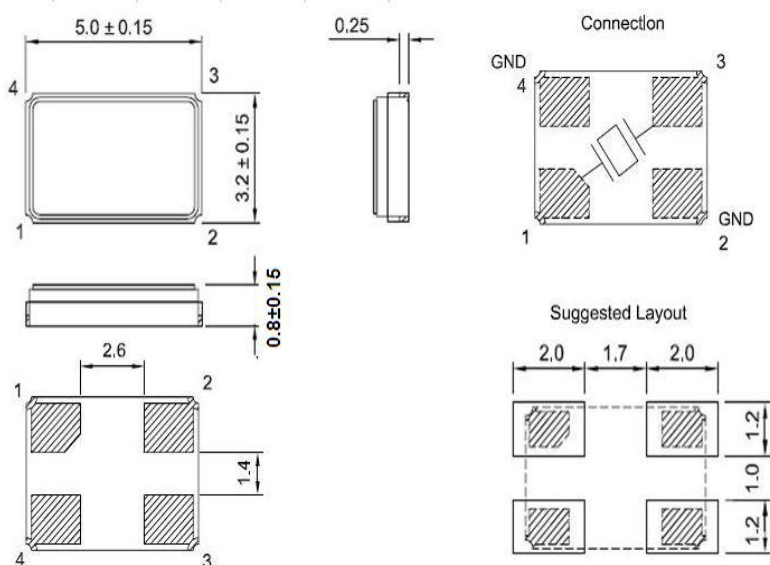
Drawn	Checked	Approved
		

RoHS Compliant

● ELECTRICAL PARAMETERS

谐振器产品技术指标		Min	Max	Units
1.Holder Type(型号规格)		SEAM 5.0*3.2		
2.Mode of Oscillation（振动模式）		Fundamental		
3. Frequency（标称频率）		8.000000		MHz
4.Load Capacitance (CL)（负载电容）		20		pF
5.Drive Level（激励功率）		100		uw
6.Equivalent Resistance（谐振电阻）			100	Ω
7.Shunt Capacitance (Co)（静态电容）		0	7	pF
8.Motional Capacitance (C1) (动态电容)		N/A		fF
9.Frequency Tolerance at 25℃（调整频差）		-30	30	ppm
10.Stability over operation temperance（温度频差）		± 30		ppm
11.Insulation Resistance (at DC 100V)（绝缘电阻）		500		M Ω
12.Operating Temperature Range（工作温度范围）		-40	85	℃
13. Storage Temperature Range（储存温度范围）		-40	85	℃
14. Aging（老化率）		± 5		ppm/year
15. DLD2	N/A		N/A	Ω
16. FLD2			N/A	ppm
17. RLD2			N/A	Ω
18. SPDB	N/A		N/A	db
19. Other(其它)		N/A		

OUTLINE DIMENSIONS(UNIT:mm) 外形尺寸（单位：mm）

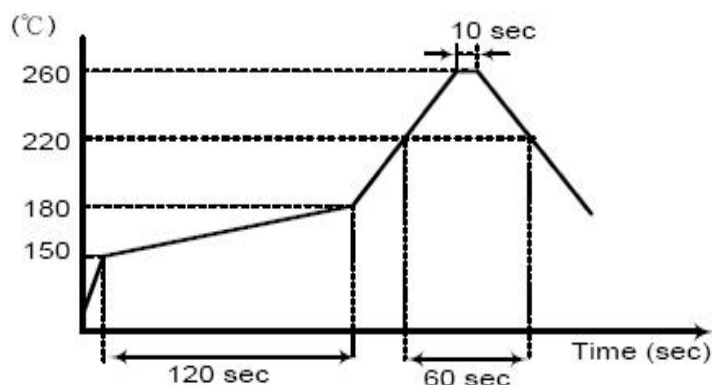


● SUGGESTED REFLOW PROFILE (回流焊曲线图)

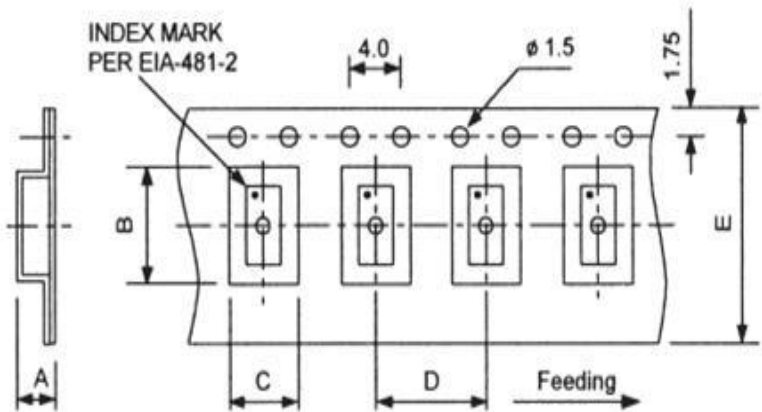
Total time:200sec.Max. (总时间: 200秒 最大)

Solder melting point:220℃ (熔点220℃)

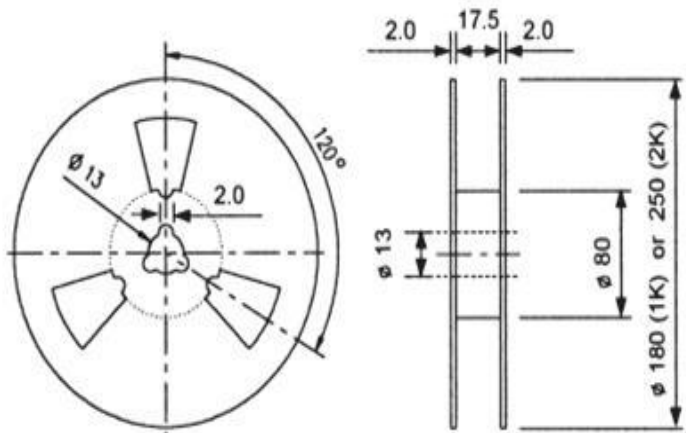
Profiles Feature (特性)		Pb-Free Assembly
Average Ramp-up Rate(Ts max to Tp)平均升温速度		3℃/second Max
Preheat	预热	
■ Temperature Min (Ts min)	最低温度	125℃
■ Temperature Max (Ts max)	最高温度	200℃
■ Time (ts min to ts max)	从最低到最高时间	(60~180) seconds
Time maintained above	维持上述时间	
■ Temperature(T1)	温度	217℃
■ Time(tp)	时间	(60~150) seconds
Peak/Classification Temperature(Tp) 最高点温度		260℃
Time within 5℃ of actual Peak Temperature(tp)	高温维持时间	(20~40) seconds
Ramp-down rate	降温速度	6℃/second max
Time 25℃ to Peak Temperature	从25℃到最高温度的时间	8 minutes max
Suggest reflow times	建议 reflow次数	3 Times max



- PACKING（包装） 1Kpcs/REEL



SIZE	
A	1.7
B	5.45
C	3.65
D	8.0
E	12.0
IK	



- REMARK :
1. 230 mm (9.05) minimum leader which consist of carrier and/or cover tape followed by a minimum of 160 mm (6.3) of empty carrier tape sealed with cover tape.
 2. 160 mm (6.3) minimum trailer of empty carrier tape sealed with cover tape.

● RELIABILITY SPECIFICATIONS (信赖度试验)

No	Test Item (测试项目)	Test Conditions (测试条件)	Reference (参考)
1	High Temperature High Humidity Storage (高温、高湿、储存)	Temperature: 85°C±3°C 温度: 85°C±3°C Relative Humidity: 85%RH 相对湿度: 85%RH Time: 96 Hours 时间: 96小时	JIS C5023
2	High Temperature Storage (高温储存)	Temperature: 125°C±3°C 温度: 125°C±3°C Time: 96 Hours 时间: 96小时	MIL-STD-883E Method 1005.8
3	Low Temperature Storage (低温储存)	Temperature: -40°C±3°C 温度: -40°C±3°C Time: 96 Hours 时间: 96小时	MIL-STD-883E Method 1013
4	Thermal Shock (温度冲击)	Temperature 1: -55°C±5°C 温度 1: -55°C±5°C Temperature 2: 85°C±5°C 温度 2: 85°C±5°C Temperature change between T1 and T2 5 min T1和T2温度在5分钟内改变 10 cycles maintain T1 and T2 for 30 minutes each moment 每次循环30分钟共10次	MIL-STD-202F Method 107 Condition A
5	RESISTANCE TO SOLDER HEAT (耐焊接热)	Solder Temperature: 260°C±5°C 焊槽温度: 260°C±5°C Time: 10±1 Seconds 时间: 10±1秒	MIL-STD-202F Method 210E
6	Solderability (可焊性)	The solder pot temperature is 245±5°C, dwell time 5±0.5s 245±5°C 焊锡槽浸润 5±0.5秒	J-STD-002B
7	Drop Test (落下试验)	3 Times Free Fall from 75cm height table to 3cm thickness hard wood board 从75cm高度3次跌落到3cm厚硬质木板上	JIS C6701
8	MECHANICAL SHOCK (机械冲击)	Half sine wave, 1000 G 半正弦波, 加速度 1000G 3 Times for all 3 directions X、Y、Z 三个相互垂直方向各三次	MIL-STD-202F Method 213B
9	Vibration (机械振动)	Frequency Range: 10Hz~55Hz 频率范围: 10Hz~55Hz Amplitude: 0.75mm 振幅: 0.75mm 2 Hours in each direction, total 6 Hours X、Y、Z 三个相互垂直方向各振动2小时	MIL-STD-883E Method 2007.3
10	Leakage Test (气密性)	Take measurements with a helium Leakage detector 氦质检漏 Leakage Rate ≤ 1×10 ⁻³ Pa cm ³ /s 漏率 ≤ 1×10 ⁻³ Pa cm ³ /s	MIL-STD-883E